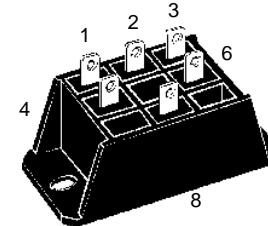
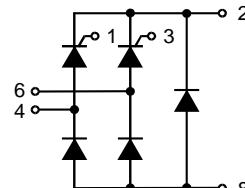


Half Controlled Single Phase Rectifier Bridge with Freewheeling Diode

$I_{dAVM} = 21 \text{ A}$
 $V_{RRM} = 800-1600 \text{ V}$

V_{RSM}	V_{RRM}	Type
V_{DSM}	V_{DRM}	
V	V	
900	800	VHF 15-08io5
1300	1200	VHF 15-12io5
1500	1400	VHF 15-14io5
1700	1600	VHF 15-16io5



Symbol	Test Conditions	Maximum Ratings		
I_{dAV}	$T_K = 85^\circ\text{C}$, module	15	A	
I_{dAVM} ①	module	21	A	
I_{FRMS}, I_{TRMS}	per leg	15	A	
I_{FSM}, I_{TSM}	$T_{VJ} = 45^\circ\text{C}$; $V_R = 0 \text{ V}$	190 210	A A	
	$T_{VJ} = T_{VJM}$ $V_R = 0 \text{ V}$	170 190	A A	
I^2t	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0 \text{ V}$	160 180	A^2s A^2s	
	$T_{VJ} = T_{VJM}$ $V_R = 0 \text{ V}$	140 145	A^2s A^2s	
$(di/dt)_{cr}$	$T_{VJ} = 125^\circ\text{C}$ $f=50 \text{ Hz}$, $t_p=200 \mu\text{s}$ $V_D = 2/3 V_{DRM}$ $I_G = 0.3 \text{ A}$, $di_G/dt = 0.3 \text{ A}/\mu\text{s}$	repetitive, $I_T = 50 \text{ A}$ non repetitive, $I_T = 1/2 \cdot I_{dAV}$	150 500	$\text{A}/\mu\text{s}$ $\text{A}/\mu\text{s}$
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}$; $V_{DR} = 2/3 V_{DRM}$ $R_{GK} = \infty$; method 1 (linear voltage rise)	1000	V/ μs	
V_{RGM}		10	V	
P_{GM}	$T_{VJ} = T_{VJM}$ $I_T = I_{TAVM}$	$t_p = 30 \mu\text{s}$ $t_p = 500 \mu\text{s}$ $t_p = 10 \text{ ms}$	≤ 10 ≤ 5 ≤ 1 0.5	W W W W
P_{GAVM}			-40...+125	$^\circ\text{C}$
T_{VJ}			125	$^\circ\text{C}$
T_{VJM}			-40...+125	$^\circ\text{C}$
T_{stg}			3000 3600	V~ V~
V_{ISOL}	50/60 Hz, RMS $I_{ISOL} \leq 1 \text{ mA}$	$t = 1 \text{ min}$ $t = 1 \text{ s}$	2-2.5 18-22 50	Nm lb.in. g
M_d	Mounting torque	(M5) (10-32 UNF)		
Weight				

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

① for resistive load

IXYS reserves the right to change limits, test conditions and dimensions.

Features

- Package with DCB ceramic base plate
- Isolation voltage 3600 V \sim
- Planar passivated chips
- 1/4" fast-on terminals
- UL registered E 72873

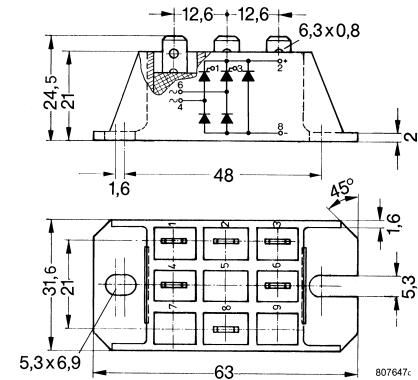
Applications

- Supply for DC power equipment
- DC motor control

Advantages

- Easy to mount with two screws
- Space and weight savings
- Improved temperature and power cycling

Dimensions in mm (1 mm = 0.0394")



Symbol	Test Conditions	Characteristic Values		
I_R, I_D	$V_R = V_{RRM}; V_D = V_{DRM}$ $T_{VJ} = T_{VJM}$ $T_{VJ} = 25^\circ C$	\leq	5	mA
		\leq	0.3	mA
V_T, V_F	$I_T, I_F = 45 A; T_{VJ} = 25^\circ C$	\leq	2.8	V
V_{TO}	For power-loss calculations only ($T_{VJ} = 125^\circ C$)	1.0		V
r_T		40		$m\Omega$
V_{GT}	$V_D = 6 V;$ $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$	\leq	1.0	V
		\leq	1.2	V
I_{GT}	$V_D = 6 V;$ $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$ $T_{VJ} = 125^\circ C$	\leq	65	mA
		\leq	80	mA
		\leq	50	mA
V_{GD}	$T_{VJ} = T_{VJM};$ $T_{VJ} = T_{VJM};$	\leq	0.2	V
I_{GD}	$V_D = 2/3 V_{DRM}$ $V_D = 2/3 V_{DRM}$	\leq	5	mA
I_L	$I_G = 0.3 A; t_G = 30 \mu s;$ $di_G/dt = 0.3 A/\mu s;$ $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$ $T_{VJ} = 125^\circ C$	\leq	150	mA
		\leq	200	mA
		\leq	100	mA
I_H	$T_{VJ} = 25^\circ C; V_D = 6 V; R_{GK} = \infty$	\leq	100	mA
t_{gd}	$T_{VJ} = 25^\circ C; V_D = 1/2 V_{DRM}$ $I_G = 0.3 A; di_G/dt = 0.3 A/\mu s$	\leq	2	μs
t_q	$T_{VJ} = 125^\circ C, I_T = 15 A, t_p = 300 \mu s, V_R = 100 V$	typ.	150	μs
Q_f	$di/dt = -10 A/\mu s, dv/dt = 20 V/\mu s, V_D = 2/3 V_{DRM}$		75	μC
R_{thJC}	per thyristor (diode); DC current		2.4	K/W
	per module		0.6	K/W
R_{thJK}	per thyristor (diode); DC current		3.0	K/W
	per module		0.75	K/W
d_s	Creepage distance on surface		12.6	mm
d_A	Creepage distance in air		6.3	mm
a	Max. allowable acceleration		50	m/s^2

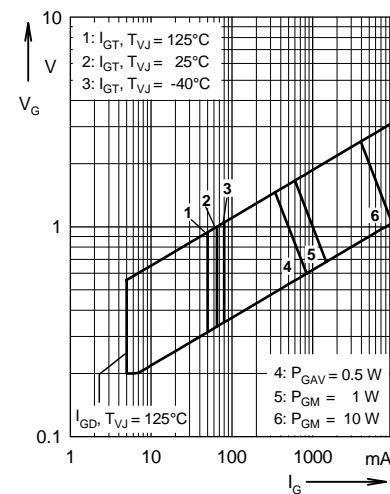
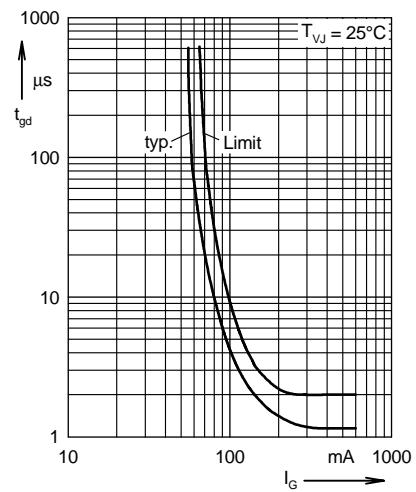


Fig. 1 Gate trigger range

Fig. 2 Gate controlled delay time t_{gd}

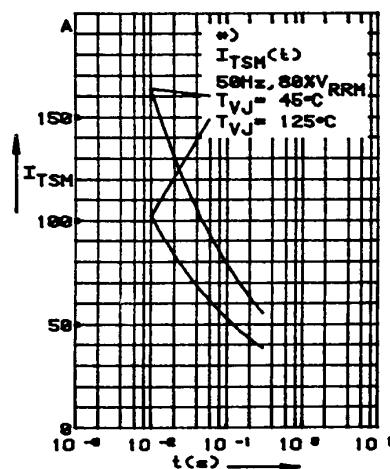


Fig. 3 Surge overload current per chip
 I_{TSM} : Crest value, t : duration

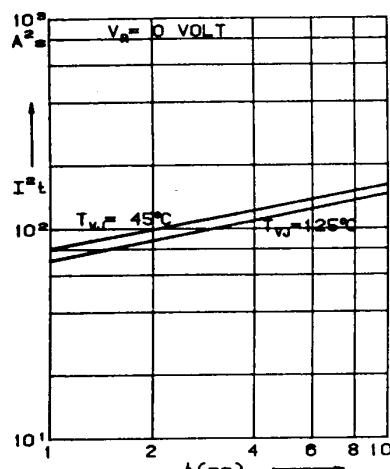


Fig. 4 I^2t versus time (1-10 ms)
per chip

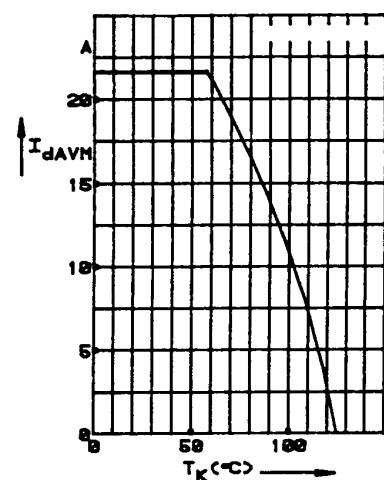


Fig. 5 Max. forward current at
heatsink temperature

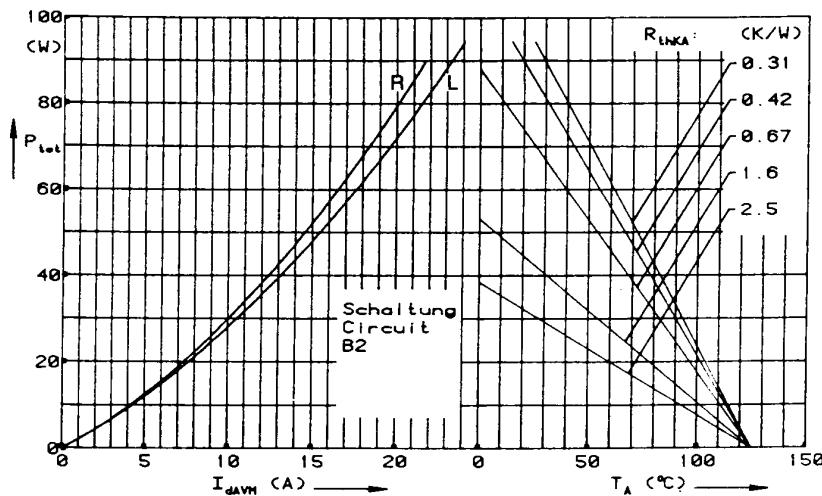


Fig. 6 Power dissipation versus direct output current and ambient temperature

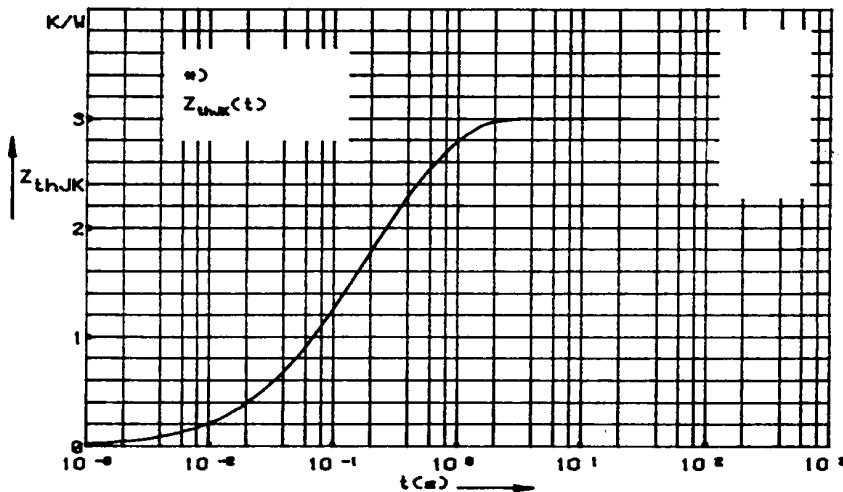


Fig. 7 Transient thermal impedance junction to heatsink per chip

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.34	0.0344
2	1.16	0.12
3	1.5	0.5